

REF1004

1.2V and 2.5V Micropower VOLTAGE REFERENCE

FEATURES

- **INITIAL ACCURACY:**
REF1004-1.2 $\pm 4\text{mV}$
REF1004-2.5 $\pm 20\text{mV}$
- **MINIMUM OPERATING CURRENT:**
REF1004-1.2 $10\mu\text{A}$
REF1004-2.5 $20\mu\text{A}$
- **EXCELLENT LONG TERM TEMPERATURE STABILITY**
- **VERY LOW DYNAMIC IMPEDANCE**
- **OPERATES UP TO 20mA**
- **PACKAGE: 8-Lead SOIC**

APPLICATIONS

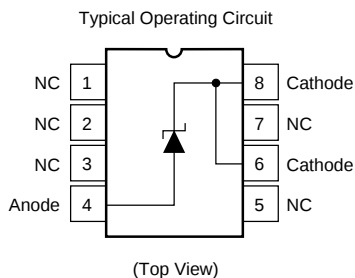
- **BATTERY POWERED TEST EQUIPMENT**
- **PORTABLE MEDICAL INSTRUMENTATION**
- **PORTABLE COMMUNICATIONS DEVICES**
- **A/D AND D/A CONVERTERS**
- **NOTEBOOK AND PALMTOP COMPUTERS**

DESCRIPTION

The REF1004-1.2 and REF1004-2.5 are two terminal bandgap reference diodes designed for high accuracy with outstanding temperature characteristics at low operating currents. Prior to the introduction of the REF1004 Micropower Voltage References, accuracy and stability specifications could only be attained by expensive screening of standard devices. The REF1004 is a cost effective solution when reference voltage accuracy, low power, and long term temperature stability are required.

REF1004 is a drop-in replacement for the LT1004 as well as an upgraded replacement of the LM185/385 series references. The REF1004C is characterized for operation from 0°C to 70°C and the REF1004I is characterized for operation from -40°C to $+85^{\circ}\text{C}$.

The REF1004 is offered in an 8-lead Plastic SOIC package and shipped in anti-static rails or tape and reel.



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SPECIFICATIONS

ELECTRICAL

$T_A = +25^{\circ}\text{C}$ unless otherwise noted.

PARAMETER	CONDITIONS	REF1004-1.2			REF1004-2.5			UNITS
		MIN	TYP	MAX	MIN	TYP	MAX	
REFERENCE VOLTAGE REF1004C ⁽¹⁾ REF1004I ⁽²⁾	$I_R = 100\mu\text{A}$	1.231 1.229 1.225	1.235 1.235 1.235	1.239 1.239 1.239	2.490 2.487 2.480	2.500 2.500 2.500	2.511 2.511 2.511	V
AVERAGE TEMPERATURE COEFFICIENT	$I_{\text{MIN}} \leq I_R \leq 20\text{mA}$		20			20		ppm/ $^{\circ}\text{C}$
MINIMUM OPERATION CURRENT ⁽³⁾			8	10		12	20	μA
REVERSE BREAKDOWN VOLTAGE CHANGE WITH CURRENT	$I_{\text{MIN}} \leq I_R \leq 1\text{mA}$ $1\text{mA} \leq I_R \leq 20\text{mA}$			1 1.5 ⁽³⁾ 10 20 ⁽³⁾			1 1.5 ⁽³⁾ 10 20 ⁽³⁾	mV
REVERSE DYNAMIC IMPEDANCE ⁽³⁾	$I_R = 100\mu\text{A}$		0.2	0.6		0.2	0.6	Ω
WIDE BAND NOISE (RMS) 10Hz $\leq I_R \leq 10\text{kHz}$	$I_R = 100\mu\text{A}$		60			120		μV
LONG TERM STABILITY $T_A = 25^{\circ}\text{C} \pm 0.1^{\circ}\text{C}$	$I_R = 100\mu\text{A}$		20			20		ppm/KHr
NOTES: (1) This specification applies over the full operating temperature range of $0^{\circ}\text{C} \leq T_A \leq 70^{\circ}\text{C}$. (2) This specification applies over the full operating temperature range of $40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$. (3) Denotes the specifications which apply over the full operating temperature range.								

ORDERING INFORMATION

MODEL	T_A	V_Z	PACKAGE
REF1004C-1.2	0°C to $+70^{\circ}\text{C}$	1.2V	8-Lead SOIC
REF1004C-2.5	0°C to $+70^{\circ}\text{C}$	2.5V	8-Lead SOIC
REF1004I-1.2	-40°C to $+85^{\circ}\text{C}$	1.2V	8-Lead SOIC
REF1004I-2.5	-40°C to $+85^{\circ}\text{C}$	2.5V	8-Lead SOIC

NOTE: Available in Tape and Reel, Add -TR to Model Number.

ABSOLUTE MAXIMUM RATINGS

Reverse Breakdown Current	30mA
Forward Current	10mA
Operating Temperature Range	
REF1004C	0°C to $+70^{\circ}\text{C}$
REF1004I	-40°C to $+85^{\circ}\text{C}$
Storage Temperature	
REF1004C	-65°C to $+150^{\circ}\text{C}$
REF1004I	-65°C to $+150^{\circ}\text{C}$
Lead Temperature (soldering, 10s)	$+300^{\circ}\text{C}$

ORDERING INFORMATION

MODEL	PART MARKING
REF1004C-1.2	BBREF0412
REF1004C-2.5	BBREF0425
REF1004I-1.2	BBREF0412
REF1004I-2.5	BBREF0425

PACKAGE INFORMATION

MODEL	PACKAGE	PACKAGE DRAWING NUMBER ⁽¹⁾
REF1004C-1.2	8-Pin SOIC	182
REF1004C-2.5	8-Pin SOIC	182
REF1004I-1.2	8-Pin SOIC	182
REF1004I-2.5	8-Pin SOIC	182

NOTE: (1) For detailed drawing and dimension table, please see end of data sheet, or Appendix D of Burr-Brown IC Data Book.

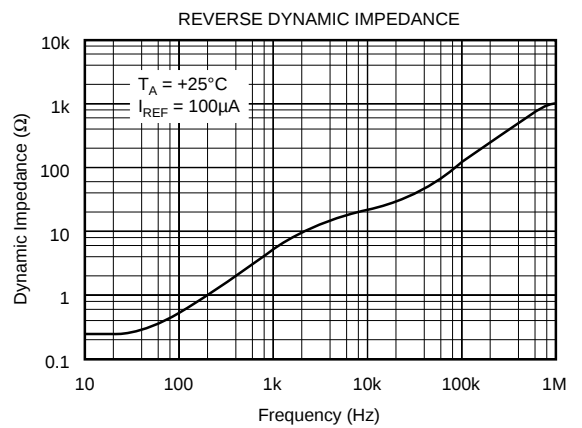
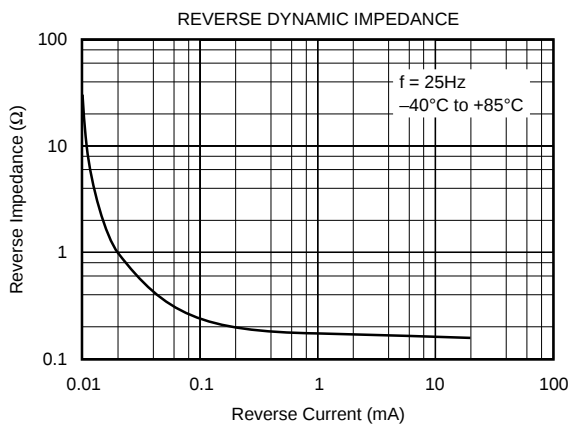
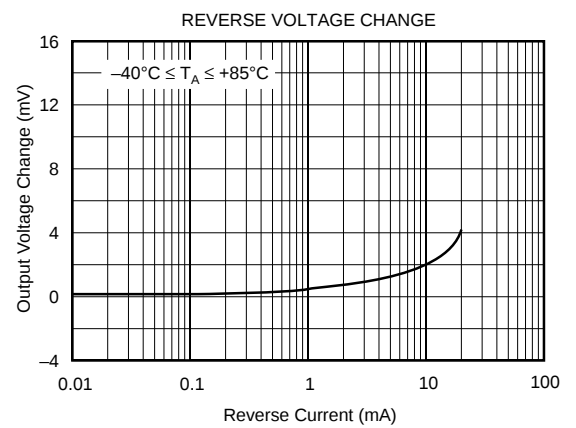
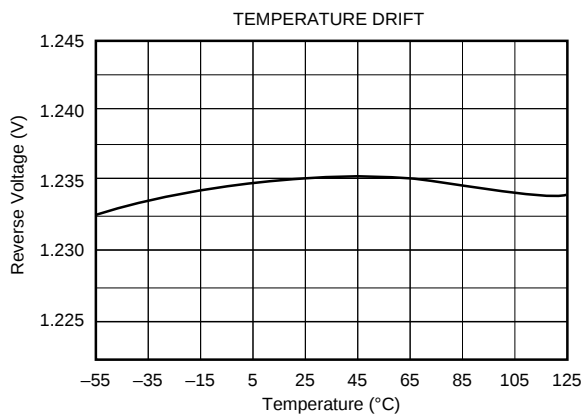
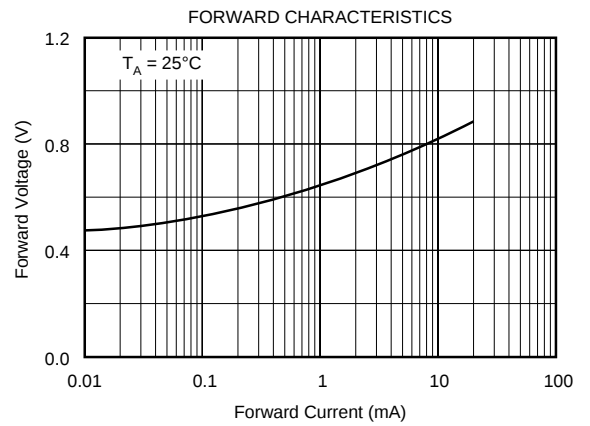
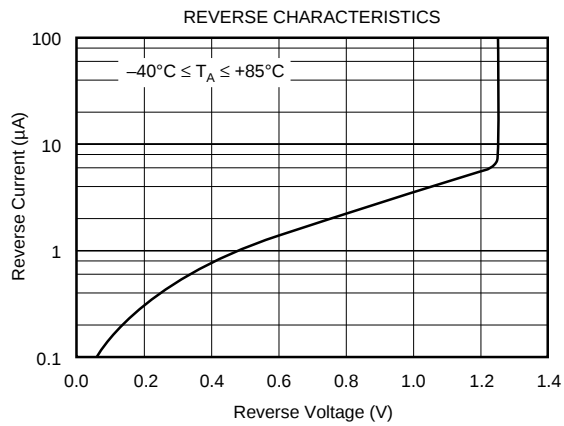
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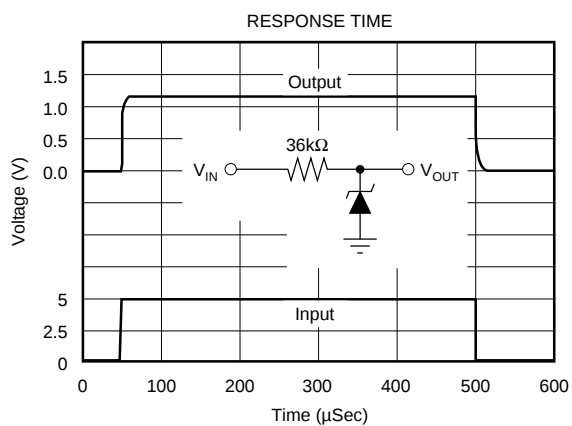
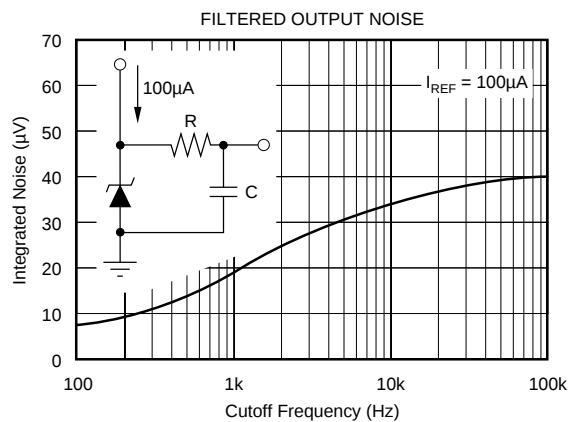
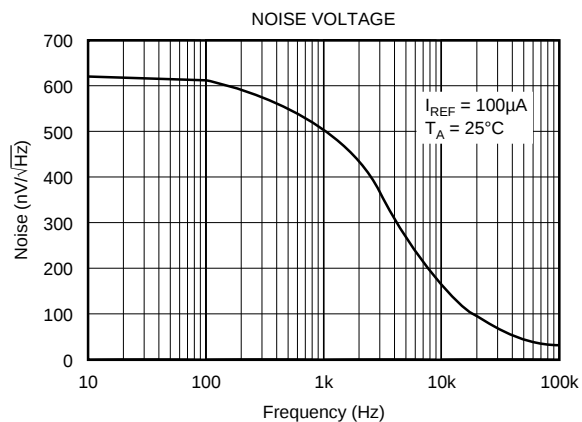
TYPICAL PERFORMANCE CURVES 1.2V

$T_A = +25^\circ\text{C}$ unless otherwise noted.



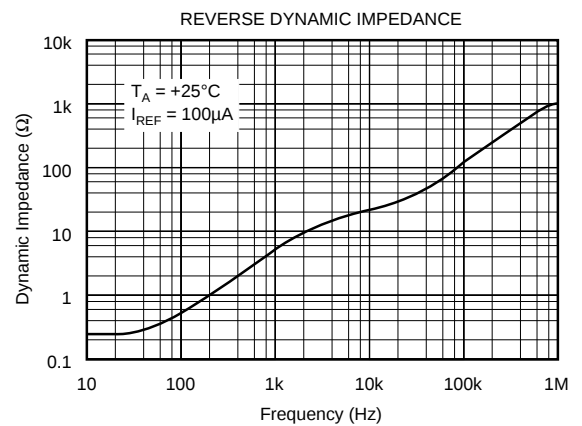
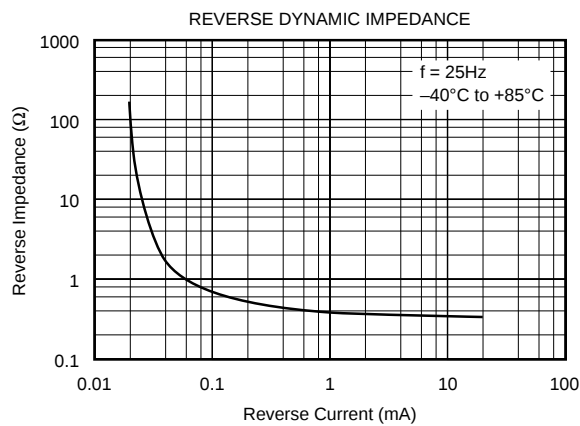
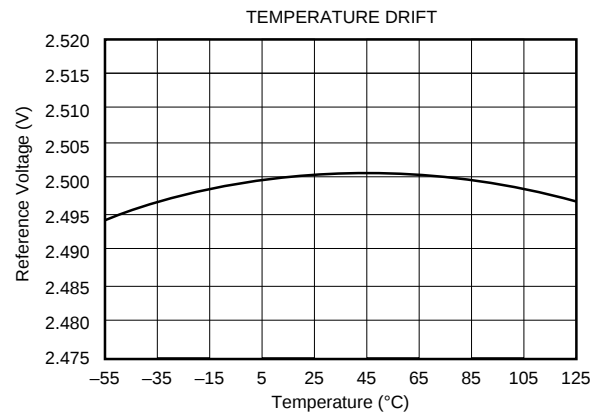
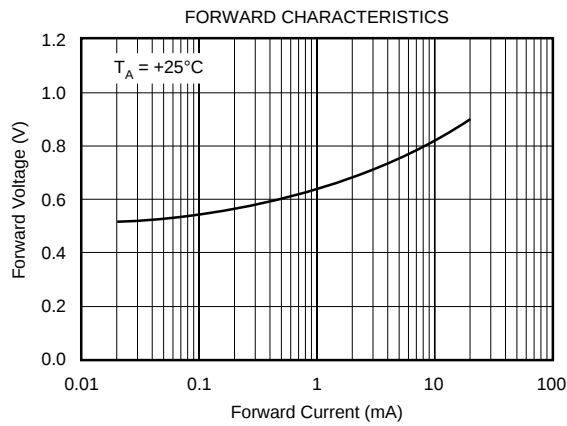
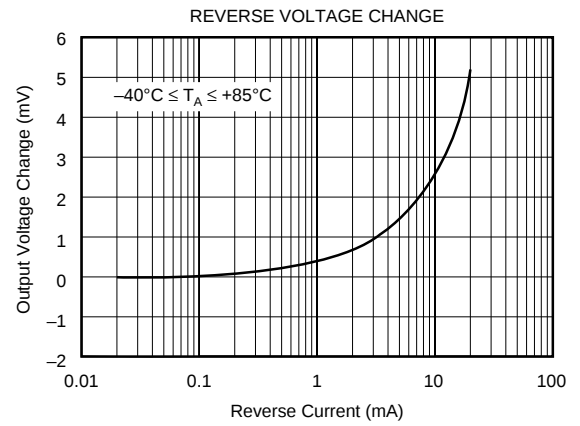
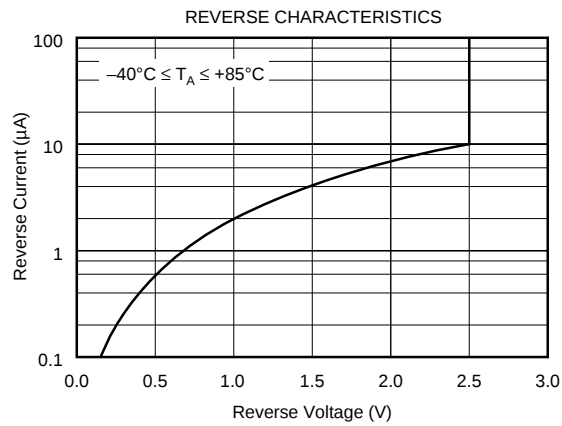
TYPICAL PERFORMANCE CURVES 1.2V (CONT)

$T_A = +25^\circ\text{C}$ unless otherwise noted.



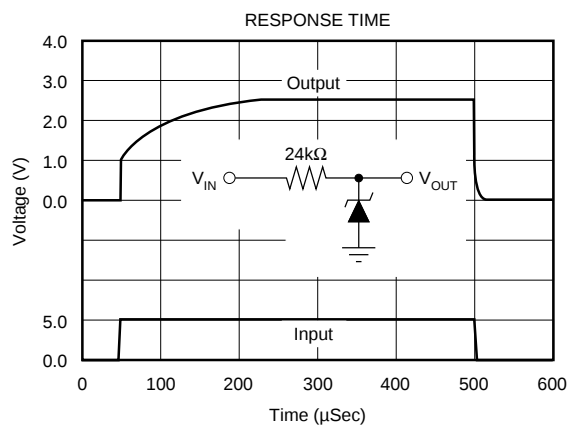
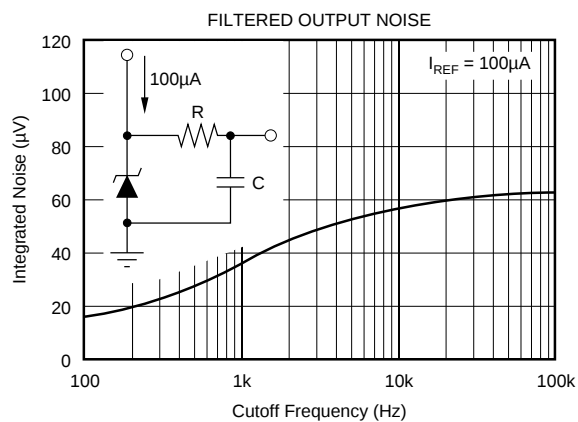
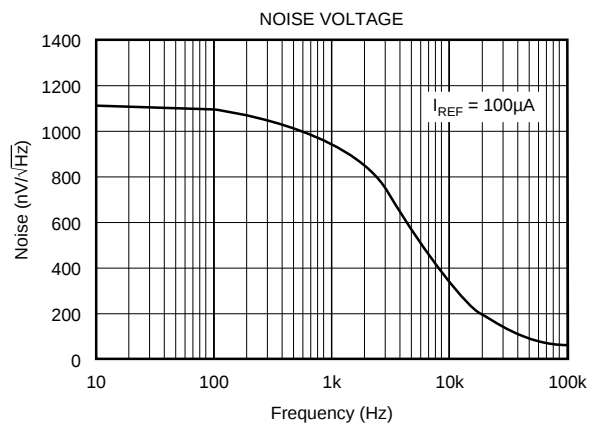
TYPICAL PERFORMANCE CURVES 2.5V

$T_A = +25^\circ\text{C}$ unless otherwise noted.



TYPICAL PERFORMANCE CURVES 2.5V (CONT)

$T_A = +25^\circ\text{C}$ unless otherwise noted.



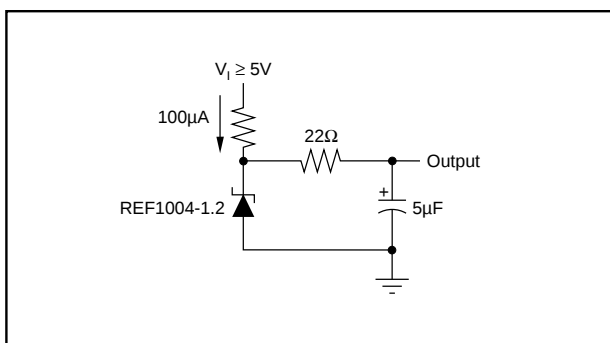


FIGURE 1. Low-Noise Reference.

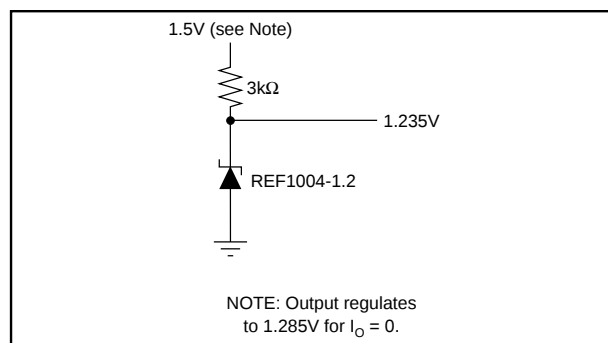


FIGURE 3. 1.2V Reference from 1.5V Battery.

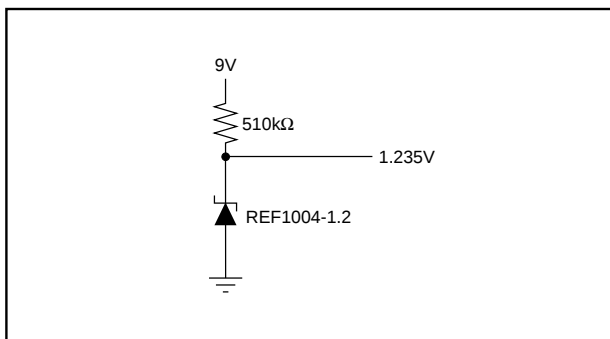


FIGURE 2. Micropower Reference from 9V Battery.

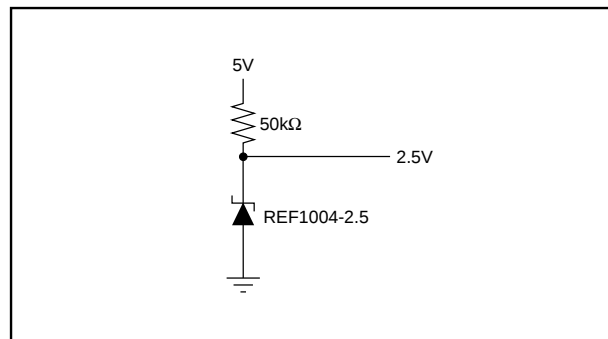


FIGURE 4. 2.5V Reference.

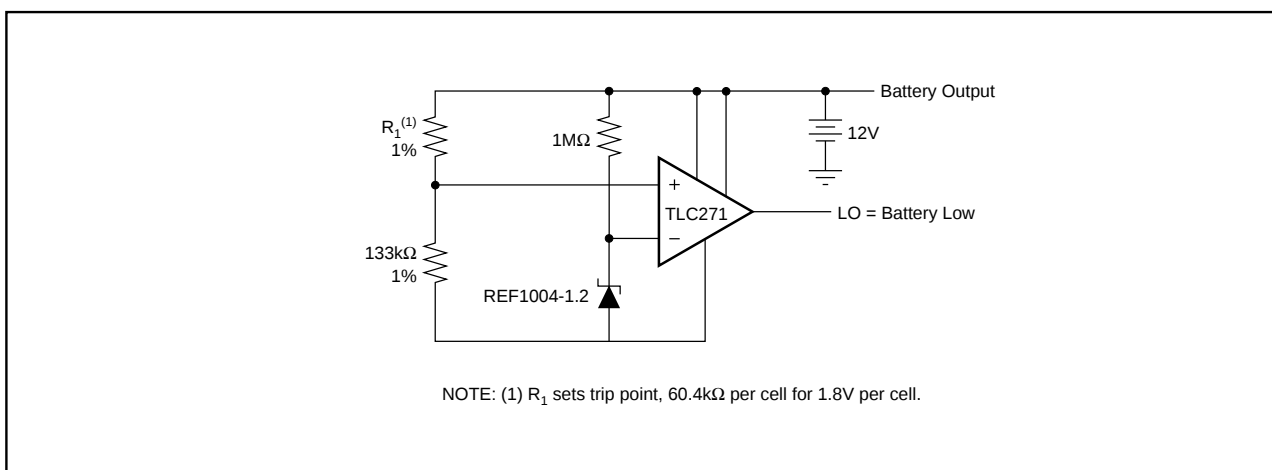


FIGURE 5. Lead-Acid Low-Battery-Voltage Detector.

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
REF1004C-1.2	ACTIVE	SOIC	D	8	75	RoHS & Green	NIPDAU	Level-3-260C-168 HR	0 to 70	REF 0412	Samples
REF1004C-1.2/2K5	ACTIVE	SOIC	D	8	2500	RoHS & Green	NIPDAU	Level-3-260C-168 HR	0 to 70	REF 0412	Samples
REF1004C-2.5	ACTIVE	SOIC	D	8	75	RoHS & Green	NIPDAU	Level-3-260C-168 HR	0 to 70	REF 0425	Samples
REF1004C-2.5/2K5	ACTIVE	SOIC	D	8	2500	RoHS & Green	NIPDAU	Level-3-260C-168 HR	0 to 70	REF 0425	Samples
REF1004I-1.2	ACTIVE	SOIC	D	8	75	RoHS & Green	NIPDAU	Level-3-260C-168 HR	-40 to 85	REF 0412	Samples
REF1004I-1.2/2K5	ACTIVE	SOIC	D	8	2500	RoHS & Green	NIPDAU	Level-3-260C-168 HR	-40 to 85	REF 0412	Samples
REF1004I-1.2E4	ACTIVE	SOIC	D	8	75	RoHS & Green	NIPDAU	Level-3-260C-168 HR	-40 to 85	REF 0412	Samples
REF1004I-2.5	ACTIVE	SOIC	D	8	75	RoHS & Green	NIPDAU	Level-3-260C-168 HR	-40 to 85	REF 0425	Samples
REF1004I-2.5/2K5	ACTIVE	SOIC	D	8	2500	RoHS & Green	NIPDAU	Level-3-260C-168 HR	-40 to 85	REF 0425	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSELETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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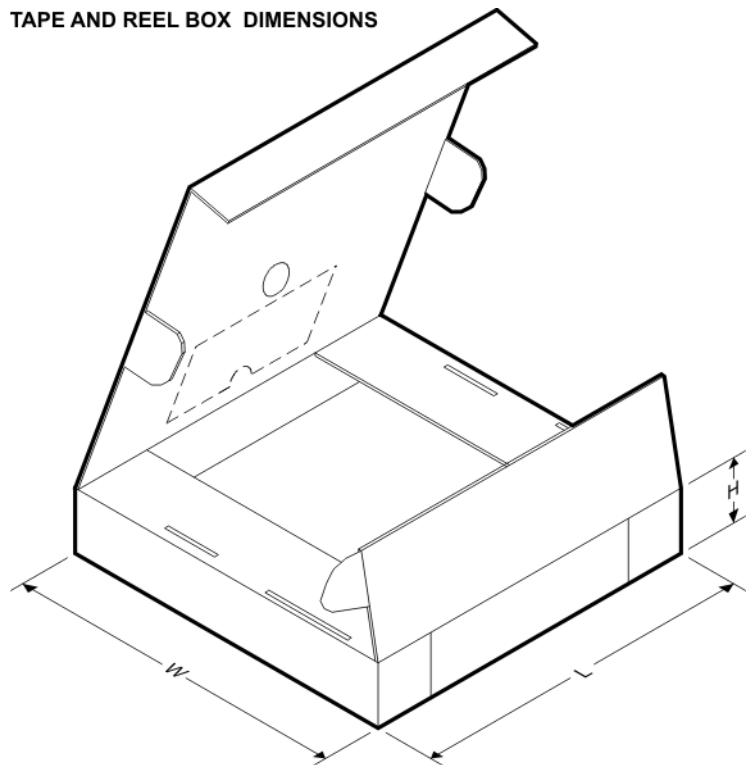
TAPE AND REEL INFORMATION



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
REF1004C-1.2/2K5	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
REF1004C-2.5/2K5	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
REF1004I-1.2/2K5	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
REF1004I-2.5/2K5	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
REF1004C-1.2/2K5	SOIC	D	8	2500	853.0	449.0	35.0
REF1004C-2.5/2K5	SOIC	D	8	2500	853.0	449.0	35.0
REF1004I-1.2/2K5	SOIC	D	8	2500	853.0	449.0	35.0
REF1004I-2.5/2K5	SOIC	D	8	2500	853.0	449.0	35.0

TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
REF1004C-1.2	D	SOIC	8	75	506.6	8	3940	4.32
REF1004C-2.5	D	SOIC	8	75	506.6	8	3940	4.32
REF1004I-1.2	D	SOIC	8	75	506.6	8	3940	4.32
REF1004I-1.2E4	D	SOIC	8	75	506.6	8	3940	4.32
REF1004I-2.5	D	SOIC	8	75	506.6	8	3940	4.32

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